

**LINEAR TECHNOLOGY MATERIALS DECLARATION**

ltc4367cms8-1#pbf

(Engineering Calculation)

MSOP

(printed on: 2020-07-11 22:36:48)

**TOTAL MASS (g) : 0.027378**

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.002079	1000000	75936.8125		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.010433	975000	381072		
		Iron (Fe)	7439-89-6	0.000257	24000	9387.08984375		
		Phosphorus (P)	7723-14-0	0.000003	300	109.576934814		
		Zinc (Zn)	7440-66-6	0.000007	700	255.679504395		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
<b>Lead Frame Total:</b>				<b>0.010700</b>	<b>1000000</b>	<b>390824.375</b>		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000710	1000000	25934.1191406		
		<b>External Plating Total:</b>				<b>0.000710</b>	<b>1000000</b>	<b>25934.1191406</b>
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000086	1000000	3141.20532227		
<b>Internal Plating Total:</b>				<b>0.000086</b>	<b>1000000</b>	<b>3141.20532227</b>		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000715	750000	26115.8320312		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000238	250000	8693.10253906		
<b>Die Attach Total:</b>				<b>0.000953</b>	<b>1000000</b>	<b>34808.9375</b>		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.001659	130000	60596.0390625		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.010591	830000	386843.09375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000447	35000	16326.9619141		
		Carbon Black (C)	1333-86-4	0.000064	5000	2337.64111328		
		<b>Encapsulation Total:</b>				<b>0.012761</b>	<b>1000000</b>	<b>466103.6875</b>
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000089	1000000	3250.78222656		
					<b>TOTAL MASS (g) :</b>	<b>0.027378</b>		